



Customer Information Notification

202104051I : i.MX 8M Dual/8M QuadLite/8M Quad Consumer and Industrial Datasheet Update to Rev.3 and Reference Manual Update to Rev.3.1

Note: This notice is NXP Company Proprietary.

Issue Date: Jul 08, 2021 **Effective date:** Jul 09, 2021

Change Category

- | | | | | |
|--|--|--|--|---|
| <input type="checkbox"/> Wafer
Fab
Process | <input type="checkbox"/> Assembly
Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test
Process | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer
Fab
Materials | <input type="checkbox"/> Assembly
Materials | <input type="checkbox"/> Mechanical
Specification | <input type="checkbox"/> Test
Equipment | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer
Fab
Location | <input type="checkbox"/> Assembly
Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test
Location | <input type="checkbox"/> Electrical
spec./Test
coverage |
| <input type="checkbox"/> Firmware | <input checked="" type="checkbox"/> Other | | | |

PCN Overview

Description

NXP Semiconductors announces Industrial and Consumer Datasheet (DS) update for i.MX 8M Dual/8M QuadLite/8M Quad to revision 3 and Reference Manual (RM) update for i.MX 8M Dual/8M QuadLite/8M Quad to revision 3.1. The revision history included in the updated document provides a detailed description of the changes.

Industrial and Consumer Datasheet Changes Summary:

Highlighted Changes:

- Updated the descriptions of PCIE_VPH in the Table 8, "Operating ranges"

Please refer the change summary for other changes.

The i.MX 8M Dual/8M QuadLite/8M Quad Industrial and Consumer Datasheet Rev.3 are attached to this notice, and can be found at:

<https://www.nxp.com/docs/en/data-sheet/IMX8MDQLQIEC.pdf>

<https://www.nxp.com/docs/en/data-sheet/IMX8MDQLQCEC.pdf>

Reference Manual Changes Summary:

- Updated the description of field 12 "PCIE1_VREG_BYPASS" in 8.2.4.15 GPR14 General Purpose Register (IOMUXC_GPR_GPR14)
- Updated the description of field 12 "PCIE2_VREG_BYPASS" in 8.2.4.17 GPR16 General Purpose Register (IOMUXC_GPR_GPR16)
- Chapter 11.4 PCIe Express PHY (PCIE_PHY) previously was an incorrect version of the spec and now has been updated with the correct version.

The i.MX 8M Dual/8M QuadLite/8M Quad Reference Manual Rev.3.1 is attached to this notice, and can be found at:

<https://www.nxp.com/docs/en/reference-manual/IMX8MDQLQRM.pdf>

Software patches are provided along with this DS and RM change, which can be found at:

<https://community.nxp.com/t5/i-MX-Processors-Knowledge-Base/i-MX-8M-Dual-8M-QuadLite-8M-Quad-Incorrect-PCIE-Supply/ta-p/1299599>

Reason

Datasheet and Reference Manual have been updated to correct errors and provide additional technical clarification on some device features. Below are the details:

The PCIE_VPH power supply is selectable in software between 1.8V and 3.3V. When the PCIE_VPH supply is configured to operate at 3.3V, the 1.8V internal regulator (disabled by default) must be enabled to prevent overstress conditions on the PCIe PHY. If the 1.8V internal regulator is left disabled when the PCIE_VPH supply is configured to operate at 3.3V, it could potentially affect reliability or cause permanent damage to the device. This impacts i.MX 8M NXP reference designs and/or customer design if PCIE_VPH is supplied with 3.3V and the internal 1.8V regulator is disabled.

3 software patches for each release are provided as per this DS and RM change to enable the 1.8V regulator by default, and they have already been included in L5.4.70_2.3.2 and later releases. NXP recommends to check the HW design for PCIE_VPH supply and configuration.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

When PCIE_VPH is supplied with 3.3V, the internal 1.8V regulator must be enabled through software configuration otherwise it will lead to overstress and could potentially affect reliability or cause permanent damage to the device.

Data Sheet Revision

A new datasheet will be issued

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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